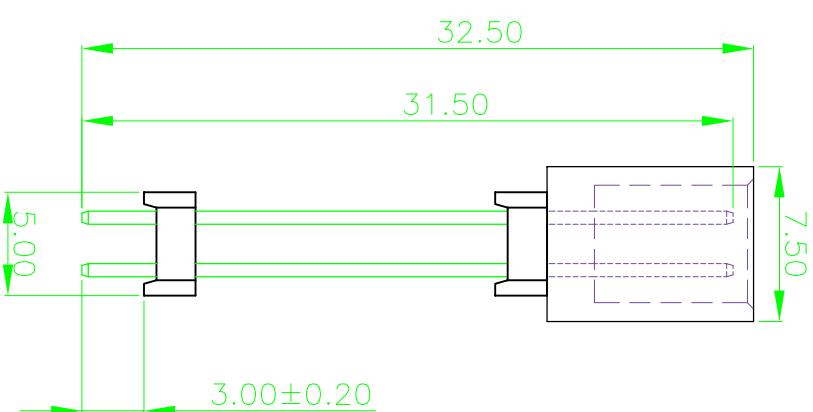


COMPLIANT RoHS

0 1 2 3 4 5 6 7 8 9 10 11

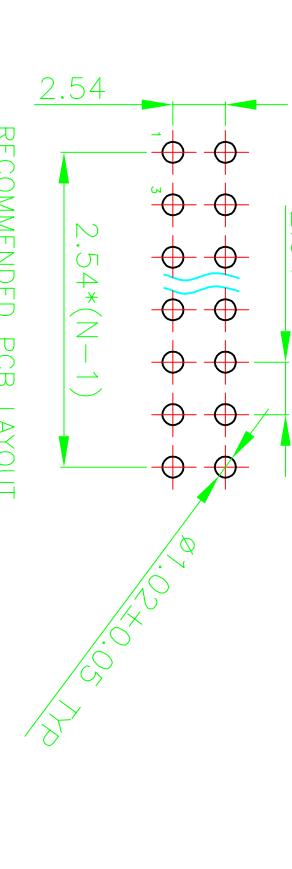


10.00



NOTES:

1. MATERIAL
 - 1.1. HOUSING: THEMPLASTIC,BLACK UL94V-0
 - 1.2. CONTACT: COPPER ALLOY
2. FINISH
 - 2.1. 1^u"MIN AU PLATED OVERALL
 - 2.2. 50^u" MIN. NICKEL UNDERPLATING OVER ALL.



RECOMMENDED PCB LAYOUT

H											
A0											
REV.	ECN NO.	INITIAL RELEASE	12/26'07	Mike, Lee	DESIGN	DATE	DESIGN				
0	1	2	3	X.XX	X.XX	10/16'14	SIZE: A4	UNIT: mm	SHEET: 1 OF 1	DRAW NAME:	
				±0.30	±0.25						
				±0.25	±0.25						
				±0.5	±0.5						

深圳市连欣科技有限公司

CUSTOMER DRAWING